

## Electronic Patent Application Fee Transmittal

Application Number:	10798540			
Filing Date:	10-Mar-2004			
Title of Invention:	Attachment of integrated circuit structures and other substrates to substrates with vias			
First Named Inventor/Applicant Name:	Sergey Savastiouk			
Filer:	Michael Shenker/Jeanne Ha			
Attorney Docket Number:	M-15302-1P US			
Filed as Large Entity				
<b>Utility Filing Fees</b>				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
<b>Extension-of-Time:</b>				
Extension - 1 month with \$0 paid	1251	1	120	120

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>120</b>